In the Claims

CLAIMS

- 1. (Currently amended) Temperature compensation apparatus for thermally loaded bodies made from materials of low <u>a</u> specific thermal conductivity, comprising:
- a heat-distributing device having one or more heat-distributing bodies; and a thermally loaded body, the heat-distributing device is adapted to surfaces of the thermally loaded body such that there remains between the thermally loaded body and the one or more heat-distributing bodies a gap which is filled with a fluid for the purpose of thermal coupling the thermally loaded body and the one or more heat-distributing bodies in conjunction with mechanical decoupling.
- 2. (Original) Temperature compensation apparatus as claimed in claim 1, wherein the fluid-filled gap is connected to a pressure-compensating device via a connection.

- 3. (Currently amended) Temperature compensation apparatus as claimed in claim 1, wherein the one or more heat-distributing bodies are solid and are made from a material of high specific thermal conductivity comprising at least one material from a group of Cu, Al, Ag, Al₂O₃ or SiC, the specific thermal conductivity being substantially higher than, in particular at least ten times as high as that of the material of which the thermally loaded body substantially consists.
- 4. (Previously presented) Temperature compensation apparatus as claimed in claim 1, wherein at least one of the one or more heat-distributing bodies is designed as a hollow body whose inner volume is filled with a fluid which executes a circulating flowing motion.
- 5. (Currently amended) Temperature compensation apparatus as claimed in claim 1, wherein at least one of the one or more heat-distributing bodies is connected via a supporting body to an external bearing structure, and is held by the latter, while there is no connection, or only a connection of very low stiffness (elastic connection) an elastic connection between the thermally loaded body and the at least one of the one or more heat-distributing bodies, as well as between the thermally loaded body and the supporting body.

- 6. (Previously presented) Temperature compensation apparatus as claimed in claim 1, wherein the one or more heat-distributing bodies are adapted to internal surfaces of the thermally loaded body.
- 7. (Original) Temperature compensation apparatus as claimed in claim 1, wherein the fluid-filled gap is connected to a sealable filling device via a connection (connecting channel).
- 8. (Previously presented) Temperature compensation apparatus as claimed in claim 4, wherein for the purpose of generating the circulating flowing motion of the fluid, which fills the one or more heat-distributing bodies designed as a hollow body, a recirculating device is connected to inlet and outlet openings of the one or more heat-distributing bodies which are provided for this purpose.
- 9. (Previously presented) Temperature compensation apparatus as claimed in claim 1, wherein at least one of the one or more heat-distributing bodies is connected to one or more heat exchange elements of a temperature controller.
- 10. (Previously presented) Temperature compensation apparatus as claimed in claim 9, wherein the one or more heat exchange elements are formed by a Peltier element.

- 11. (Original) Temperature compensation apparatus as claimed in claim 8, wherein a temperature controller of the flowing fluid is inserted into the circuit of this fluid.
- 12. (Previously presented) Temperature compensation apparatus for reflecting layer supports or substrates in optics, comprising:
- a heat-distributing device having one or more heat-distributing bodies; and a substrate comprising a thermally loaded body, the heat-distributing device is adapted to surfaces of the thermally loaded body such that there remains between the thermally loaded body and the heat-distributing bodies a gap which is filled with a fluid for the purpose of thermal coupling of said thermally loaded body and said heat-distributing bodies in conjunction with mechanical decoupling.
- 13. (Currently amended) Temperature compensation apparatus as claimed in claim 12, wherein the fluid-filled gap is connected to a pressure-compensating device via a connection, i.e. a volume-compensating channel.
- 14. (Currently amended) Temperature compensation apparatus as claimed in claim 12, wherein the heat-distributing bodies are solid and are made from a material of high specific thermal conductivity comprising at least one material from a group of Cu, Al, Ag, Al₂O₃ or SiC, the specific thermal conductivity being substantially higher than, in particular at least ten times as high as that of the material of which the thermally loaded body substantially consists.

- 15. (Previously presented) Temperature compensation apparatus as claimed in claim 12, wherein at least one of the one or more heat-distributing bodies is designed as a hollow body whose inner volume is filled with a fluid which executes a circulation.
- 16. (Previously presented) Temperature compensation apparatus as claimed in claim 12, wherein at least one of the one or more heat-distributing bodies is connected via a supporting body to an external bearing structure, and is held by the latter, while there is no connection, or only a connection of very low stiffness between the thermally loaded body and the at least one of the one or more heat-distributing bodies, as well as between said thermally loaded body and said supporting body.
- 17. (Previously presented) Temperature compensation apparatus as claimed in claim 12, wherein the one or more heat-distributing bodies are adapted to internal surfaces of the thermally loaded body.
- 18. (Original) Temperature compensation apparatus as claimed in claim 12, wherein the fluid-filled gap is connected to a sealable filling device via a connection.

- 19. (Previously presented) Temperature compensation apparatus as claimed in claim 15, wherein for the purpose of generating the circulation of the fluid, which fills the one or more heat-distributing bodies designed as a hollow body, a recirculating device is connected to inlet and outlet openings of the one or more heat-distributing bodies which are provided for this purpose.
- 20. (Previously presented) Temperature compensation apparatus as claimed in claim 12, wherein at least one of the one or more heat-distributing bodies is connected to one or more heat exchange elements of a temperature controller.
- 21. (Previously presented) Temperature compensation apparatus as claimed in claim 20, wherein the one or more heat exchange elements are formed by a Peltier element.
- 22. (Original) Temperature compensation apparatus as claimed in claim 19, wherein a temperature controller of the flowing fluid is inserted into the circuit of this fluid.

- 23. (Previously presented) Temperature compensation apparatus as claimed in claim 12, wherein the substrate comprises an optical substrate with a surface, and wherein at least one of the one or more heat-distributing bodies is provided with a multiplicity of finger-type projections which are good thermal conductors and are aligned at least approximately perpendicular to the optical surface as antecedent basis.
- 24. (Original) Temperature compensation apparatus as claimed in claim 23, wherein the projections reach up to near the optical surface.

Claim 25 (Canceled).

- 26. (Previously presented) Temperature compensation apparatus as claimed in claim 1, wherein the thermally loaded body comprises a microlithographic projection exposure objective having at least one mirror support, and wherein the at least one mirror support is provided with the heat-distributing device.
- 27. (Previously presented) Temperature compensation apparatus as claimed in claim 12, wherein the thermally loaded body comprises a microlithographic projection exposure objective having at least one mirror support, and wherein the at least one mirror support is provided with the heat-distributing device.

28. (New) Temperature compensation apparatus as claimed in claim 13, wherein the fluid-filled gap is connected to the pressure-compensating device via a volume-compensating channel.